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FCPF380N60E_F152 N-Channel SuperFET[®] II MOSFET 600 V, 10.2 A, 380 mΩ

Features

- 650 V @T_J = 150°C
- Max. R_{DS(on)} = 380 mΩ
- Ultra Low Gate Charge (Typ. Q_g = 34 nC)
- Low Effective Output Capacitance (Typ. C_{oss} .eff = 97 pF)
- 100% Avalanche Tested

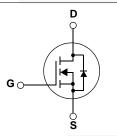
Aplications

- LCD / LED / PDP TV Lighting
- Solar Inverter
- AC-DC Power Supply



Description

SuperFET[®]II MOSFET is Fairchild Semiconductor[®], s first generation of high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate and higher avalanche energy. Consequently, SuperFET[®]II MOSFET is suitable for various AC/DC power conversion for system miniaturization and higher efficiency.



MOSFET Maximum Ratings T_C = 25°C unless otherwise noted

Symbol		Parameter		FCPF380N60E_F152	Unit	
V _{DSS}	Drain to Source Voltage			600	V	
V _{GSS}	Gate to Source Voltage	- DC		±20	V	
		- AC	(f > 1Hz)	±30	V	
	Drain Current	-Continuous (T _C = 25°C)		10.2*	Α	
D		-Continuous ($T_C = 100^{\circ}C$)		6.4*		
I _{DM}	Drain Current	- Pulsed	30.6*	А		
E _{AS}	Single Pulsed Avalanche Energy (Note 2)			211.6	mJ	
I _{AR}	Avalanche Current (Note 1)		2.3	Α		
E _{AR}	Repetitive Avalanche Energy (Note 1)		1.06	mJ		
	Peak Diode Recovery dv/dt	(Note 3)	20	V/ns		
dv/dt	MOSFET dv/dt	100	V/ns			
P _D	Dower Dissinction	$(T_{C} = 25^{\circ}C)$		31	W	
	Power Dissipation	- Derate above 25°C		0.25	W/ºC	
T _J , T _{STG}	Operating and Storage Temp	erature Range		-55 to +150	°C	
TL	Maximum Lead Temperature 1/8" from Case for 5 Seconds	ead Temperature for Soldering Purpose, tase for 5 Seconds		300	°C	

*Drain current limited by maximum junction temperature

Thermal Characteristics

Symbol	Parameter	FCPF380N60E_F152	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	4	
$R_{\theta CS}$	Thermal Resistance, Case to Heat Sink (Typical)	0.5	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient	62.5	

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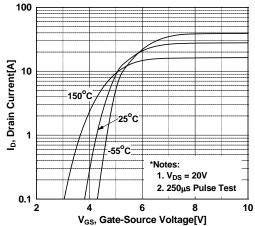
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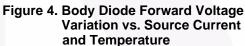
FCPF380	arking	Device	Package Eco Statu		Packaging Type			Quantit	ty
FCPF380N60E FCPF380N60E_F152		TO-220F	O-220F Green 🧭		Tube		50		
		f "green" Eco Status, please vis racteristics $T_{C} = 25^{\circ}$			<u>y/green/r</u>	ohs_green.	<u>html</u> .		
Symbol		Parameter		Test Conditions		Min.	Тур.	Max.	Uni
Off Charac	cteristi	CS							
BV _{DSS}	Drain	o Source Breakdown Voltag	V _{GS}	$V_{GS} = 0V, I_{D} = 10mA, T_{J} = 25^{\circ}C$		600	-	-	V
		rain to Source Breakdown Voltage		$V_{GS} = 0V, I_D = 10mA, T_J = 150^{\circ}C$		650	-	-	V
ΔBV _{DSS} ΔTJ	Break	down Voltage Temperature	$I_D =$	$I_D = 10$ mA, Referenced to 25°C		-	0.67	-	V/ºC
BV _{DS}	Drain- Voltag	Source Avalanche Breakdov	wn V _{GS}	V _{GS} = 0V, I _D = 10A		-	700	-	V
			Vps	= 480V, V _{GS} = 0V		-	-	10	
I _{DSS}	Zero G	Bate Voltage Drain Current		= 480V, $T_{C} = 125^{\circ}C$		-		10	μA
I _{GSS}	Gate t	o Body Leakage Current		$= \pm 20V, V_{DS} = 0V$		-	-	±100	nA
	torioti			50					
On Charac			14	N/ 1 050 A		0.5		2.5	V
V _{GS(th)}		Threshold Voltage		$= V_{DS}, I_D = 250 \mu A$		2.5	-	3.5	V
R _{DS(on)}		Drain to Source On Resista		$= 10V, I_D = 5A$		-	0.32	0.38	Ω
9FS	Forwa	rd Transconductance	V DS	= 20V, I _D = 5A		-	10	-	S
Dynamic C	Charact	teristics							
C _{iss}	Input C	Capacitance		$V_{DS} = 25V, V_{GS} = 0V$ f = 1MHz		-	1330	1770	pF
C _{oss}	Output	Capacitance				-	945	1260	pF
C _{rss}	Revers	se Transfer Capacitance				-	60	90	pF
C _{oss}	Output	Capacitance	-	= 380V, V _{GS} = 0V, f = 1N	ИНz	-	25	-	pF
C _{oss} eff.		ve Output Capacitance	V _{DS}	$V_{DS} = 0V \text{ to } 480V, V_{GS} = 0V$ $V_{DS} = 380V, I_D = 5A$ $V_{GS} = 10V$ (Note 4) $f = 1MHz$		-	97	-	pF
Q _{g(tot)}		Sate Charge at 10V				-	34	45	nC
Q _{gs}	Gate to	o Source Gate Charge				-	5.3	-	nC
Q _{gd}	Gate to	o Drain "Miller" Charge	V GS			-	13	-	nC
ESR	Equiva	lent Series Resistance	f = 1			-	6	-	Ω
Switching	Chara	cteristics							
t _{d(on)}		n Delay Time				-	17	44	ns
t _r		Turn-On Rise Time		V _{DD} = 380V, I _D = 5A		-	9	28	ns
t _{d(off)}		off Delay Time	V _{GS}	$V_{GS} = 10V, R_G = 4.7\Omega$		-	64	138	ns
t _f	Turn-Off Fall Time			(Note 4)		-	10	30	ns
Drain-Sou		de Characteristics							
	_	um Continuous Drain to Sou				-	·	10.2	А
I _S I _{SM}		um Pulsed Drain to Source				-	-	30.6	A
V _{SD}		o Source Diode Forward Vo		= 0V, I _{SD} = 5A		-	-	1.2	V
t _{rr}		e Recovery Time	8 00	= 0V, I _{SD} = 5A			240	-	ns
Q _{rr}		e Recovery Charge		lt = 100A/μs		-	3	-	μC

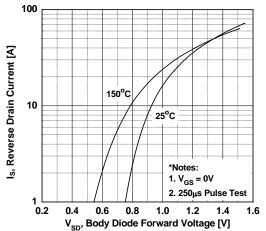
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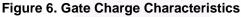
Typical Performance Characteristics Figure 1. On-Region Characteristics 100 100 $V_{GS} = 15.0V$ 10.0V 8.0V 7.0V 6.0V Drain Current[A] I_D, Drain Current[A] 10 10 5.5V 5.0V 4.5V 1 ق *Notes: 1. 250µs Pulse Test 2. T_C = 25^oC 0.1 ∟ 0.1 0.1 10 20 2 1 V_{DS}, Drain-Source Voltage[V] Figure 3. On-Resistance Variation vs. **Drain Current and Gate Voltage** 0.8 100 Reverse Drain Current [A] R_{DS(ON)} [Ω], 10 $V_{GS} = 10V$ V_{GS} = 20V <u></u>, *Note: T_C = 25°C 0.2 1 0 5 10 15 25 20 30 I_D, Drain Current [A] **Figure 5. Capacitance Characteristics** 10000 10 Gate-Source Voltage [V] Ciss 8 1000 Capacitances [pF] 6 100 Coss 4 *Note: 1. $V_{GS} = 0V$ 10 V_{GS}, (2. f = 1MHz 2 Ciss = Cgs + Cgd (Cds = shorted) Coss = Cds + Cgd Crss 1 Crss = Cgd 0 0.5 0.1 10 100 600 1 V_{DS}, Drain-Source Voltage [V]

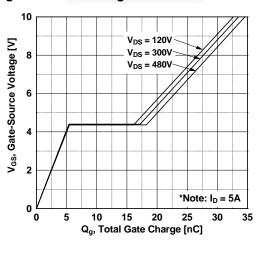
Figure 2. Transfer Characteristics





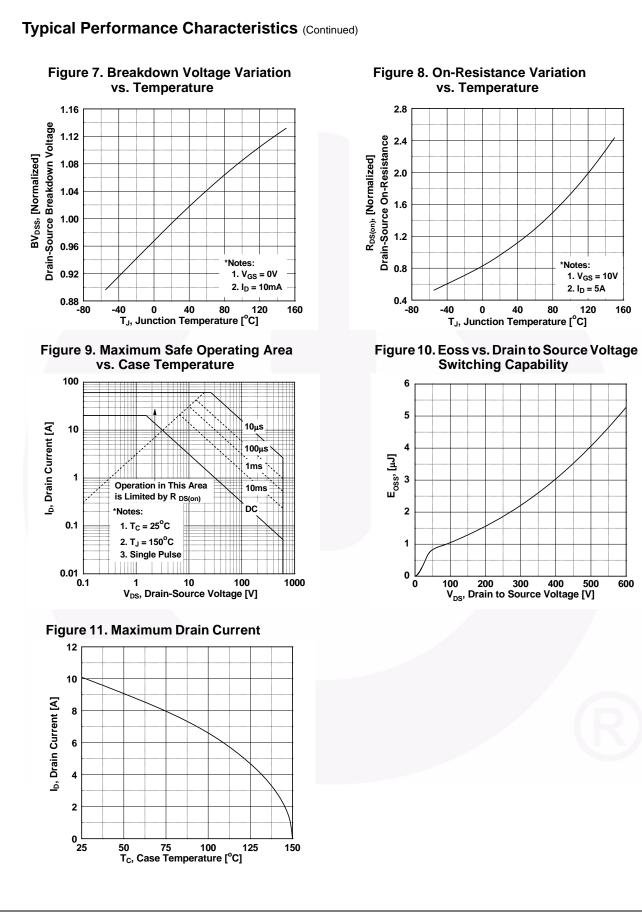






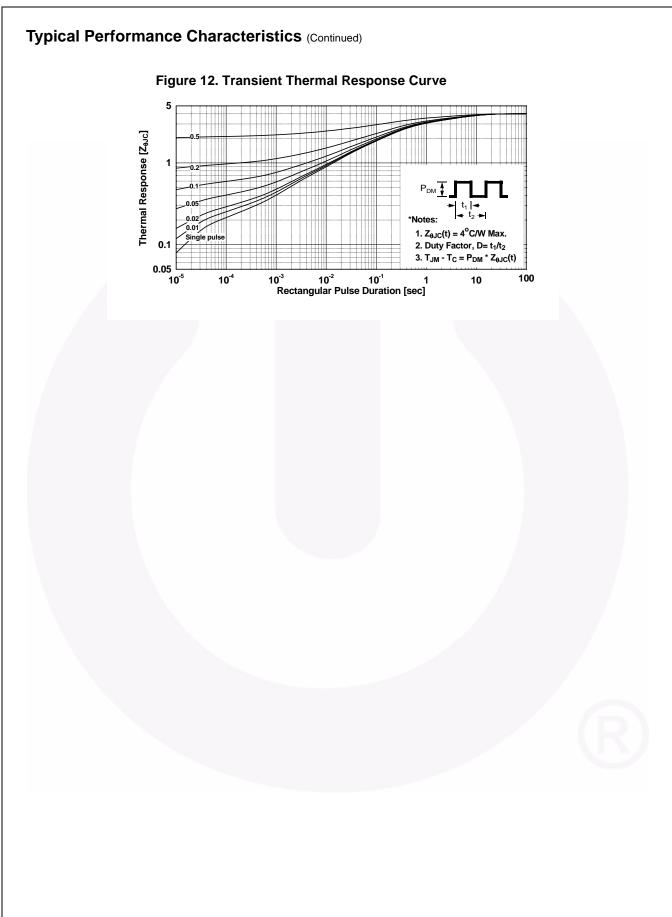
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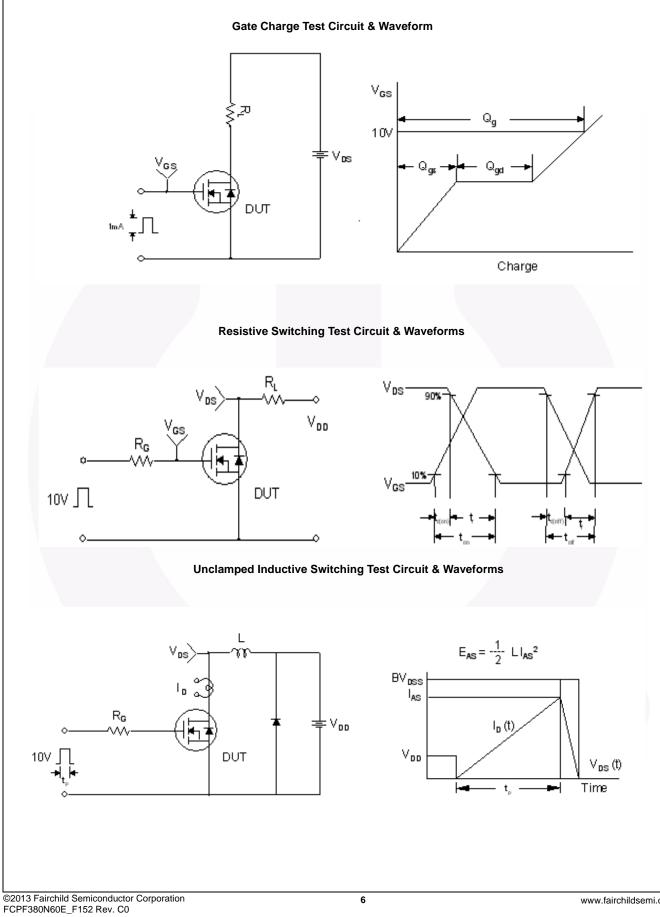
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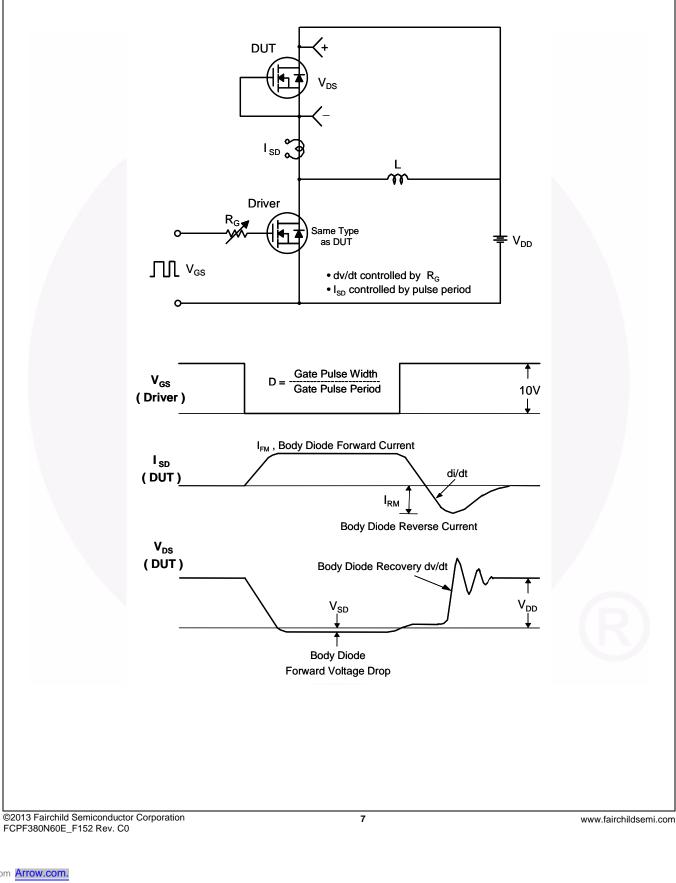
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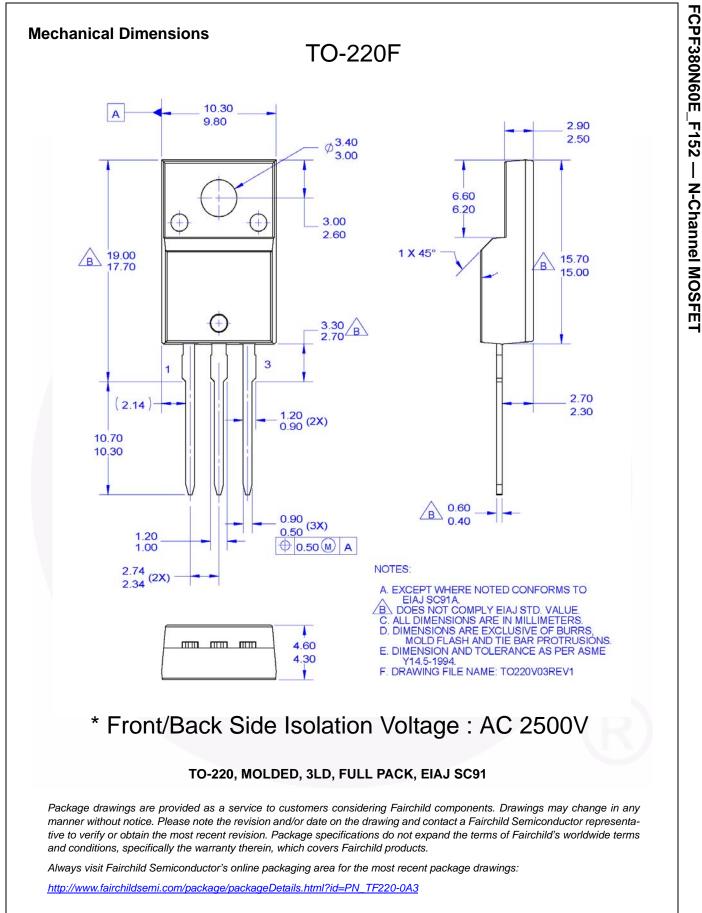
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Peak Diode Recovery dv/dt Test Circuit & Waveforms





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